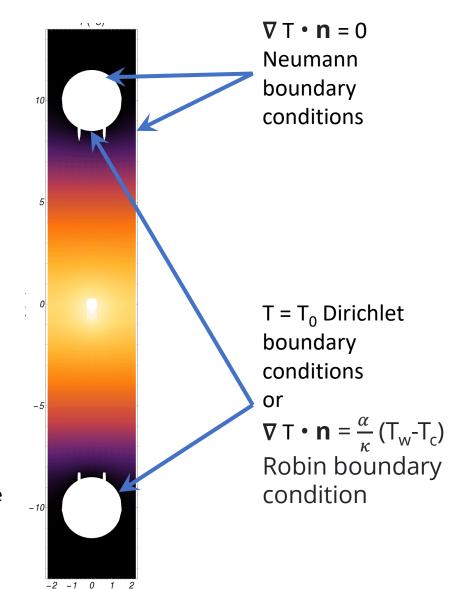


Hovanes Egiyan

TEMPERATURE EVALUATION FOR KLCPS59 MODEL

Presented method

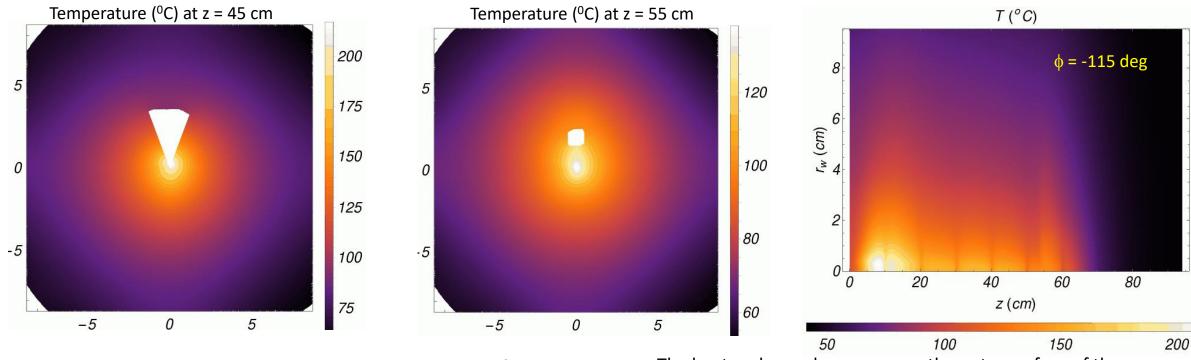
- The goal of this method is to obtain temperature distribution estimates for the CPS core using a quicker method than full ANSYS
 - Only concentrate on the copper core area to get 3D solutions for the equations in a uniform medium.
- Use Poisson's equation with boundary condition to determine the Tdistribution.
 - Use finely binned data from FLUKA simulations by Pavel.
 - The solutions for the equations are assumed to be time-independent.
- Solve the equations using *Mathematica* software.
 - JLAB owns license for CUE Linux machines.
 - Can solve Poisson's equation in both Cartesian, Spherical and Cylindrical coordinates.
 - Small details like small 2mm cuts e.t.c. are ignored in geometry.
 - Assumes heat exchange at the boundary with the cooling water which is at some average temperature.
 - Water flow is assumed to be sufficient.
- I this point the warming of the water in the pipes is not taken into account
 - Use effective temperature.
- Already checked against Tim's ANSYS calculations for many KLF heated items.



used $k = 385 \frac{\text{W}}{\text{K m}}$

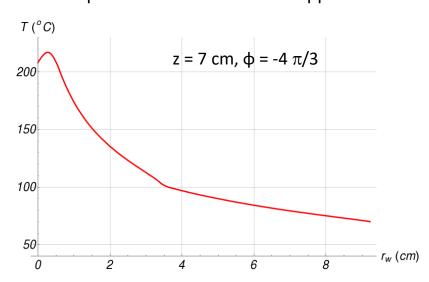
$$-\nabla^2 \mathsf{T}(\mathsf{x},\mathsf{y},\mathsf{z}) = \frac{1}{k} \mathsf{q} \; (\mathsf{x},\mathsf{y},\mathsf{z})$$

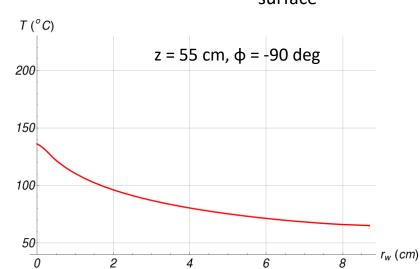
$$-\nabla^2 \mathsf{T}(\mathsf{r}, \phi, \mathsf{z}) = \frac{1}{k} \mathsf{q} (\mathsf{r}, \phi, \mathsf{z})$$

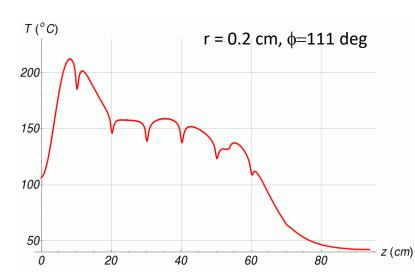


- There is a hot spots at z=7cm, close to the upstream edge of the absorber
- Maximum temperature is about T_{max} ≈220 °C.
- Temperature at the water-to copper interface is about 80 °C.

- The heat exchange happens over the outer surface of the copper rectangular block
- used α = (5000/4) $\frac{W}{K \text{ m}^2}$ to be conservative on the heat exchange surface







- Cooling channels:
 - 2 horizontal slits are 12cm x1cm
 - 2 round holes R=1cm
- used α = $5000 \frac{W}{K \text{ m}^2}$ for heat exchange at the surface.
- Maximum temperature is about T_{max} ≈190 °C.
- Temperature at the water-to copper interface is about 50 degrees.
- Assuming ∆T=5 °C temperature change for water, this will require ~60gal/min flow.
 - Need to decrease the mass flow of water by increasing ΔT.
 - Need to increase the water velocity.
- Will be optimized later when Pavel's model is final.

